PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants Chad A. Cobbley et al.

Serial No. : 10/077,554

Filing Date February 15, 2002

For Molded Stiffener For Thin Substrates

Examiner ; TRINH, Hoa B.

Group Art Unit 2814
Confirmation No. 3265

CERTIFICATION OF SUBMISSION

I hereby certify that, on the date shown below, this correspondence is being transmitted via the Patent Electronic Filing System (EFS) addressed to Examiner TRINH at the U.S. Patent and Trademark Office.

Date: May 30, 2008

Commissioner for Patents P.O. Box 1450

Alexandria, VA 22313-1450

Communication re. Information Disclosure Statement

Sir:

Enclosed is a <u>copy</u> of an Information Disclosure Statement (IDS) that was filed electronically in the U.S. Patent and Trademark Office on <u>July 22, 2005</u>.

Also enclosed is a copy of the *USPTO Acknowledgement Receipt* indicating receipt of the IDS with a timestamp of 2005-07-22 10:06:45 EDT.

No fee is due for consideration of this item.

Applicant respectfully requests that the listed reference be made of record in the present application, and that an initialed copy of Form 1449 indicating consideration of this reference by the Examiner be returned to Applicant.

, 2008

Dated: ///wy 2

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Respectfully submitted,

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ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18
Stylesheet Version v18.0

Title of Invention

Molded Stiffener for Thin Substrates

Application Number:

10/077554

10/077554

Confirmation Number:

3265

First Named Applicant:

Chad Cobbley

Attorney Docket Number: MTI-31591

Art Unit:

2814

Examiner:

Hoa B. Trinh

Search string:

(6326544 or 6724071).pn.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite,No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	6326544	2001-12-04	Lake		174	52.2
	2	6724071	2004-04-20	Combs	٠,	257	666

Signature

Examiner Name	Date

UNITED STATES PATENT AND TRADEMARK OFFICE ACKNOWLEDGEMENT RECEIPT

Electronic Version 1.1 Stylesheet Version v1.1.1

Title of Invention

Molded Stiffener for Thin Substrates

Submission Type:

Information Disclosure Statement

Application Number:

10/077554

10/077554

EFS ID:

88676

Server Response:

Confirmation Code	Message			
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First Named Applicant:

Chad Cobbley

Attorney Docket Number: MTI-31591

Timestamp:

2005-07-22 10:06:45 EDT

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File Listing:

Doc. Name	File Name	Size (Bytes)
us-ids	MTI-31591-usidst.xml	1206
us-ids	บร-ids.dtd	7763
us-ids	us~ids.xsl	12026
package-data	MTI-31591-pkda.xml	1734
package-data	package-data.dtd	27025
package-data	us-package-data.xsl	19263
	Total files size	69017

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